

EMIPAK 1B PressFit Power Module 650 V HF Output Rectification, Flexible Configuration, 20 A



EMIPAK 1B (package example)

PRIMARY CHARACTERISTICS				
D1 - D12				
V _{RRM}	650 V			
V _{FM} typical at 20 A	1.70 V			
I _O at T _{SINK} = 99 °C	20 A			
t _{rr} typical at 20 A	65 ns			
Package	EMIPAK 1B			
Circuit configuration	6 x independent ultrafast rectifiers legs for output rectification			
Туре	Modules - diode, FRED Pt®			

FEATURES

- FRED Pt® diode technology
- Exposed Al₂O₃ substrate with low thermal resistance



- Ultra soft reverse recovery
- · Low internal inductances
- Qualified using AQG324 guideline as reference
- PressFit pins locking technology PATENT(S): www.vishav.com/patents
- Material categorization: for definitions of compliance please see <u>www.vishay.com/doc?99912</u>

DESCRIPTION

The EMIPAK 1B package is easy to use thanks to the PressFit pins. The exposed substrate provides improved thermal performance.

The optimized layout also helps to minimize stray parameters, allowing for better EMI performance.

ABSOLUTE MAXIMUM RATINGS				
PARAMETER	SYMBOL	TEST CONDITIONS	MAX.	UNITS
Operating junction temperature	TJ		175	°C
Storage temperature range	T _{Stg}		-40 to +150	C
RMS isolation voltage	V _{ISOL}	$T_J = 25$ °C, all terminals shorted, $f = 50$ Hz, $t = 1$ s	3500	V
D1 - D12				
Maximum average ferward current (per diade)	_	T _{SINK} = 25 °C	31	_
Maximum average forward current (per diode)	I _{F(AV)}	T _{SINK} = 80 °C	23	Α
Dower discipation	В	T _{SINK} = 25 °C	68	W
Power dissipation	P_D	T _{SINK} = 80 °C	43	VV
Maximum peak one cycle forward non-repetitive	I _{FSM}	10 ms sine or 6 ms rectangular pulse, $T_J = 25 ^{\circ}\text{C}$, no voltage reapplied	160	Α
surge current	-1 SIVI	8.3 ms sine, T _J = 25 °C, no voltage reapplied	167	Α
Manifestor 124 annuals little for final and	I ² t	No voltage reapplied, t = 10 ms	128	A ² s
Maximum I ² t capability for fusing	1-1	No voltage reapplied, t = 8.3 ms	117	A-S
Maximum I ² √t capability for fusing	I²√t	t = 0.1 ms to 10 ms, no voltage reapplied	1281	A²√s
Repetitive peak reverse voltage	V_{RRM}		650	V
Low level value of threshold voltage	V _{F(TO)1}	(16.7 % x $I_{F(AV)} < I < x I_{F(AV)}$), $T_J = T_J$ maximum	1.03	V
High level value of threshold voltage	V _{F(TO)2}	$T_{O)2}$ (I > x I _{F(AV)}), $T_J = T_J$ maximum		V
Low level value of forward slope resistance			39.6	m0
High level value of forward slope resistance	r _{f2}	$(I > x I_{F(AV)}), T_J = T_J \text{ maximum}$	38.3	mΩ

PATENT(S): www.vishay.com/patents

This Vishay product is protected by one or more United States and international patents.



ELECTRICAL SPECIFICATIONS (T _J = 25 °C unless otherwise noted)							
PARAMETER	SYMBOL	SYMBOL TEST CONDITIONS		TYP.	MAX.	UNITS	
D1 - D12	D1 - D12						
Forward voltage drop	\/	I _F = 20 A	-	1.70	2.10	V	
Torward voltage drop	V_{FM}	I _F = 20 A, T _J = 175 °C	-	1.33	-	v	
Breakdown voltage	V_{BR}	I _R = 100 μA	650	-	-	V	
Reverse leakage current	I	V _R = 650 V	-	0.3	10	μA	
neverse leakage current	IRM	V _R = 650 V, T _J = 175 °C	-	90	-	μΑ	

SWITCHING CHARACTERISTICS (T _J = 25 °C unless otherwise noted)							
PARAMETER	SYMBOL	TEST CONDITIONS	MIN.	TYP.	MAX.	UNITS	
D1 - D12							
Diode reverse recovery time	t _{rr}	V _B = 400 V,	-	65	-	ns	
Diode reverse recovery current	I _{rr}	I _F = 20 A,	-	8.5	-	Α	
Diode reverse recovery charge	Q _{rr}	dl/dt = 500 A/µs	-	275	-	nC	
Diode reverse recovery time	t _{rr}	V _B = 400 V,	-	111	-	ns	
Diode reverse recovery current	I _{rr}	I _F = 20 A,	-	14.8	-	Α	
Diode reverse recovery charge	Q _{rr}	dl/dt = 500 A/μs, T _J = 125 °C	-	821	-	nC	

INTERNAL NTC - THERMISTOR SPECIFICATIONS						
PARAMETER	SYMBOL	SYMBOL TEST CONDITIONS VALUE				
Resistance	R ₂₅	T _C = 25 °C	5000	Ω		
Resistance	R ₁₀₀	T _C = 100 °C	493 ± 5 %	22		
B-value	B _{25/50}	$R_2 = R_{25} \exp[B_{25/50}(1/T2 - 1/(298.15K))]$	3375 ± 5 %	K		
Maximum operating temperature			220	°C		
Dissipation constant			2	mW/°C		
Thermal time constant			8	s		

THERMAL AND MECHANICAL SPECIFICATIONS						
PARAMETER	SYMBOL	MIN.	TYP.	MAX.	UNITS	
D1 - D12 - thermal resistance junction to sink (per diode) (1)	R _{thJS}	-	1.83	-	°C/W	
Case to sink thermal resistance (per module) (1)		-	0.1	-	C/VV	
Mounting torque (M4)		2	-	3	Nm	
Weight		-	28	-	g	

Note

 $^{^{(1)}}$ $\,$ Mounting surface flat, smooth, and greased, λ_{grease} = 0.67 W/mK



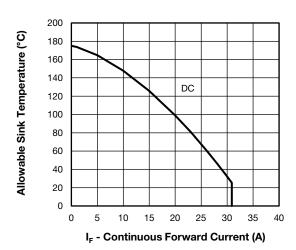


Fig. 1 - Allowable Sink Temperature vs. Continuous Forward Current (Forward Current vs. Sink Temperature)

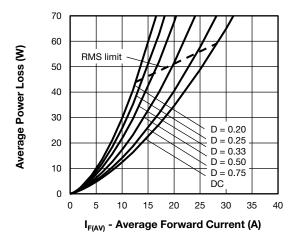


Fig. 2 - Average Power Loss vs. Average Forward Current (Forward Power Loss Characteristics)

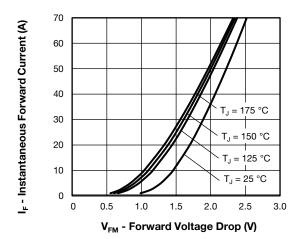


Fig. 3 - Typical Forward Voltage Drop vs. Instantaneous Forward Current (Per Diode)

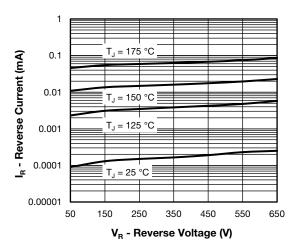


Fig. 4 - Typical Reverse Current vs. Reverse Voltage (Per Diode)

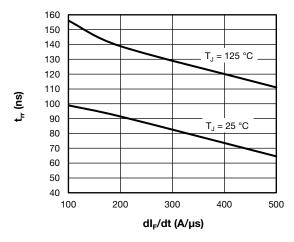


Fig. 5 - Typical Reverse Recovery Time vs. dI_F/dt (Per Diode) $V_{rr} = 400 \text{ V}, I_F = 20 \text{ A}$

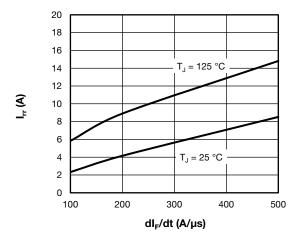


Fig. 6 - Typical Reverse Recovery Current vs. dI_F/dt (Per Diode) $V_{rr} = 400 \text{ V}, I_F = 20 \text{ A}$

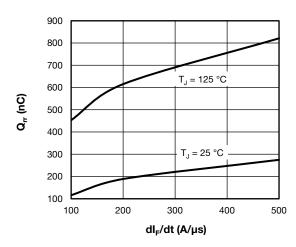
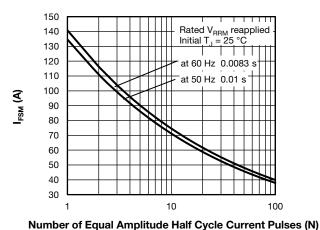
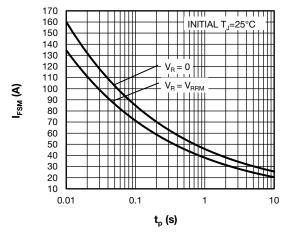


Fig. 7 - Typical Reverse Recovery Charge vs. dI_F/dt (Per Diode) $V_{rr} = 400 \ V, \, I_F = 20 \ A$



realiser of Equal Ampheude Fluir Oyole Guirent'i dioes (14)

 $\label{eq:Fig. 8-IFSM} \mbox{Fig. 8-I}_{\rm FSM} \mbox{ vs. N} \\ \mbox{(Non-Repetitive Peak Forward Surge Current vs. Number Pulses)}$



 $\label{eq:Fig.9} \textit{Fig. 9} - \textit{I}_{FSM} \, \textit{vs. t}_{p} \\ \textit{(Non-Repetitive Peak Forward Surge Current vs Pulse Duration)}$

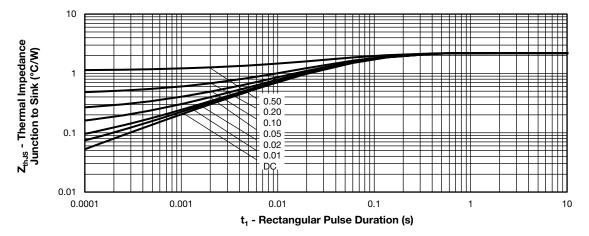


Fig. 10 - Z_{thJS} Thermal Impedance Junction to Sink vs. t1 Rectangular Pulse Duration (Maximum Thermal Impedance Z_{thJS} Characteristics Per Diode)

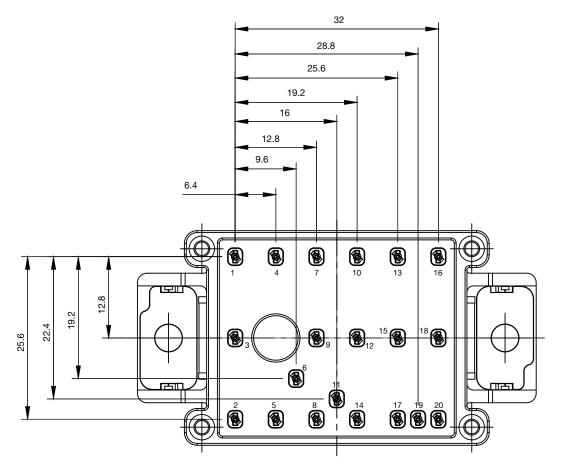


www.vishay.com

Vishay Semiconductors

CIRCUIT CONFIG	CIRCUIT CONFIGURATION							
CIRCUIT	CIRCUIT CONFIGURATION CODE			(CIRCUIT DE	RAWING		
		1	4	7	10	13	16	
		D1	D3	D5	D7	D9	D11	
6 x independent ultrafast rectifiers legs for output	afast put V	3 0	6 🔾	9 🗪	12 🗨	15 🗨	18 🗨	0 19
rectification		D2	D4	D6	D8	D10	D12	Th O 20
		0 2	5	o 8	O	O 14	O 17	

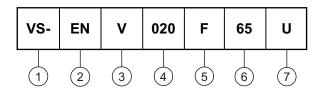
PACKAGE





ORDERING INFORMATION TABLE

Device code



1 - Vishay Semiconductors product

2 - Package indicator (EN = EMIPAK 1B)

3 - Circuit configuration (V = 6 x independent ultrafast rectifiers legs for output rectification)

4 - Current rating (020 = 20 A)

5 - Switch die technology (F = FRED Pt® diode)

6 - Voltage rating (65 = 650 V)

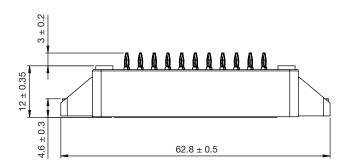
7 - Diode die technology (U = FRED Pt diode with ultra soft reverse recovery)

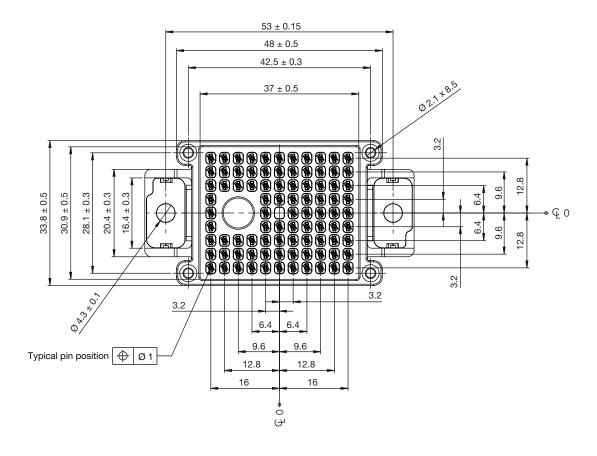
LINKS TO RELATED DOCUMENTS					
Dimensions <u>www.vishay.com/doc?95558</u>					
Application Note	www.vishay.com/doc?95580				



EMIPAK-1B PressFit

DIMENSIONS in millimeters







Legal Disclaimer Notice

Vishay

Disclaimer

ALL PRODUCT, PRODUCT SPECIFICATIONS AND DATA ARE SUBJECT TO CHANGE WITHOUT NOTICE TO IMPROVE RELIABILITY, FUNCTION OR DESIGN OR OTHERWISE.

Vishay Intertechnology, Inc., its affiliates, agents, and employees, and all persons acting on its or their behalf (collectively, "Vishay"), disclaim any and all liability for any errors, inaccuracies or incompleteness contained in any datasheet or in any other disclosure relating to any product.

Vishay makes no warranty, representation or guarantee regarding the suitability of the products for any particular purpose or the continuing production of any product. To the maximum extent permitted by applicable law, Vishay disclaims (i) any and all liability arising out of the application or use of any product, (ii) any and all liability, including without limitation special, consequential or incidental damages, and (iii) any and all implied warranties, including warranties of fitness for particular purpose, non-infringement and merchantability.

Statements regarding the suitability of products for certain types of applications are based on Vishay's knowledge of typical requirements that are often placed on Vishay products in generic applications. Such statements are not binding statements about the suitability of products for a particular application. It is the customer's responsibility to validate that a particular product with the properties described in the product specification is suitable for use in a particular application. Parameters provided in datasheets and / or specifications may vary in different applications and performance may vary over time. All operating parameters, including typical parameters, must be validated for each customer application by the customer's technical experts. Product specifications do not expand or otherwise modify Vishay's terms and conditions of purchase, including but not limited to the warranty expressed therein.

Hyperlinks included in this datasheet may direct users to third-party websites. These links are provided as a convenience and for informational purposes only. Inclusion of these hyperlinks does not constitute an endorsement or an approval by Vishay of any of the products, services or opinions of the corporation, organization or individual associated with the third-party website. Vishay disclaims any and all liability and bears no responsibility for the accuracy, legality or content of the third-party website or for that of subsequent links.

Except as expressly indicated in writing, Vishay products are not designed for use in medical, life-saving, or life-sustaining applications or for any other application in which the failure of the Vishay product could result in personal injury or death. Customers using or selling Vishay products not expressly indicated for use in such applications do so at their own risk. Please contact authorized Vishay personnel to obtain written terms and conditions regarding products designed for such applications.

No license, express or implied, by estoppel or otherwise, to any intellectual property rights is granted by this document or by any conduct of Vishay. Product names and markings noted herein may be trademarks of their respective owners.